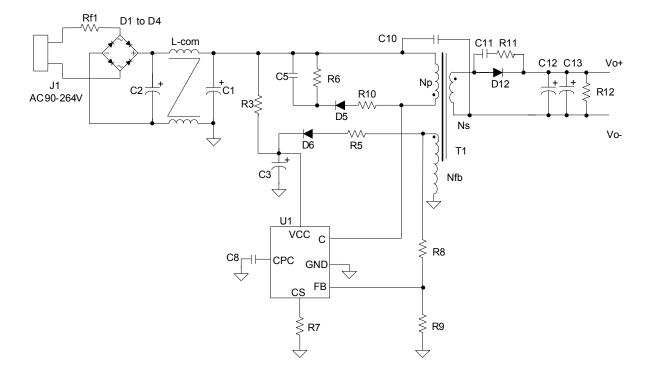




Typical Applications Circuit



For AP3971 (12V/1A)

Item	Function	QTY	Item	Function	QTY
C1,C2	10µF/400V, electrolytic	2	U1	AP3971, PDIP-7	1
C3	4.7µF/50V, electrolytic	1	Rf1	2A/250V, fuse	1
C5	1nF/250V, ceramic	1	R3	3.3MΩ/0.25W	1
C8	0.1µF, 0805	1	R5	3.9 Ω , 0805	1
C10	1nF/250V _{AC} , Y1 capacitor	1	R6	150kΩ/0.25W	1
C11	1nF, 0805	1	R7	0.62Ω, 1206	1
C12, C13	470µF/16V	2	R8	31kΩ, 0805	1
D1 to D6	1N4007, rectifier diode	6	R9	13kΩ, 0805	1
D12	MBR3100, schottky diode	1	R10	360Ω, 0805	1
L-com	EE10, 15mH, Common inductor	1	R11	27Ω, 0805	1
T1	EE19 core, PC40, transformer	1	R12	1.2kΩ, 0805	1

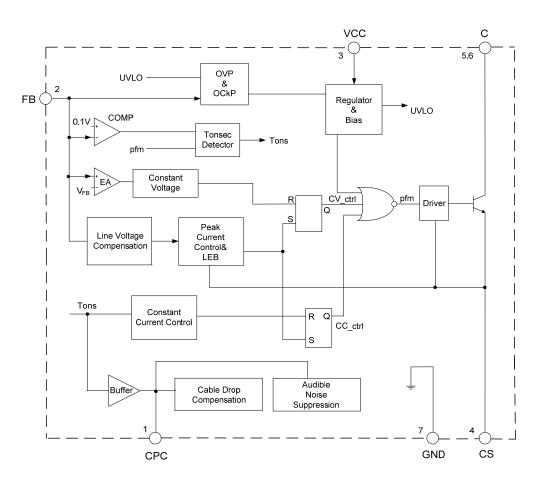




Pin Descriptions

Pin Number	Pin Name	Function	
1	CPC	This pin connects a capacitor to GND for output cable compensation	
2	FB	The voltage feedback from auxiliary winding	
3	VCC	This pin receives rectified voltage from the auxiliary winding of the transformer	
4	CS	Current sense for primary side of transformer	
5, 6	С	This pin is connected with an internal power BJT's collector	
7	GND	This pin is the signal reference ground	

Functional Block Diagram







Absolute Maximum Ratings (Note 5) Symbol Rating Unit Parameter Supply Voltage -0.3 to +22 V Vcc FB Input Voltage -1 to +10 V V_{FB} V V_{CBO} Collector-emitter Voltage 700 AP3965 1.5 Collector DC Current AP3966 3.2 А _ AP3971 4 °C T_J **Operating Junction Temperature** 150 °C Storage Temperature -65 to +150 T_{STG} Lead Temperature (Soldering, 10 sec) 300 °C $\mathsf{T}_{\mathsf{LEAD}}$ ESD (Machine Model) 200 ٧ _ 2000 _ ESD (Human Body Model) V AP3965 0.9 AP3966 P_{D} **Total Power Dissipation** 1.4 W AP3971 1.5

Note: 5. Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "Recommended Operating Conditions" is not implied. Exposure to "Absolute Maximum Ratings" for extended periods may affect device reliability.

Recommended Operating Conditions

Symbol	mbol Parameter		Max	Unit
V _{CC}	Supply Voltage	-	22	V
T _{OP}	Operating Temperature Range	-40	+85	°C
f _{MAX}	Maximum Operating Frequency	-	60	kHz

Thermal Impedance (Note 6)

Symbol	Parameter	Value		Unit
ΑLΘ	Junction to Ambient	AP3965	80	
		AP3966	50	
		AP3971	45	°C/W
	Junction to Case	AP3965	40	C/VV
$\theta_{\rm JC}$		AP3966	26	
		AP3971	22	

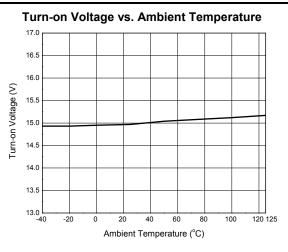
Note: 6. When mounted a standard single-sided FR4 board with 300mm² Cu (at least 35μm thick) connected to all collectors and CS pins.



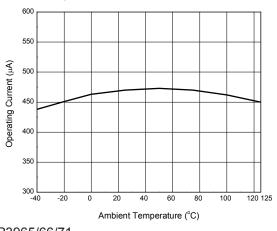


Symbol	Parameters	Conditions	Min	Тур	Max	Unit
JVLO Section						
Von	Turn-on Voltage	-	13	15	17	V
V _{OFF}	Turn-off Voltage	No drive current	4.5	5.3	6.3	V
Standby Current Se	ction					
I _{ST}	Start-up Current	$V_{CC} = V_{ON} - 0.5V$	-	0.2	0.6	
Icc	Operating Current	-	320	435	550	μA
Feedback Input Sec	tion					
I _{FB}	FB Input Current	V _{FB} = 4V	1.5	3.5	5.5	μA
V _{FB}	FB Threshold Voltage	-	4.324	4.4	4.476	V
Power Transistor Se	ection					
V _{CE(SAT)}	Collector-emitter Saturation Voltage	AP3965: I _C = 0.5A AP3966/71: I _C = 1A	-	_	0.3	V
	DC Current Gain	AP3965	14	17	-	
h _{FE}	DC Current Gain	AP3966/71	17	26	-	_
ICEO	Leakage Current	-	-	_	60	nA
Over Temperature P	rotection					
T _{SHDN}	Shutdown Temperature	Surface temperature	125	160	-	°C
_	Temperature Hysteresis	_	_	40	_	°C

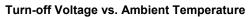
Performance Characteristics

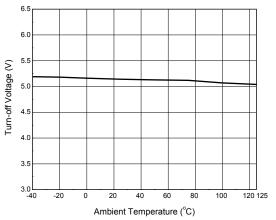


Operating Current vs. Ambient Temperature



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Operation Description

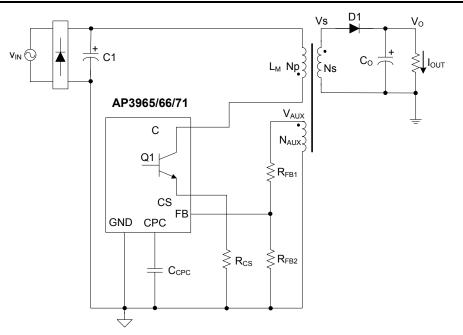


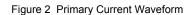
Figure 1 Simplified Flyback Converter Controlled by AP3965/66/71

Constant Primary Peak Current

The primary current Ip(t) is sensed by a current sense resistor R_{CS} as shown in Figure 1.

The current rises up linearly at a rate of:

$$\frac{dip(t)}{dt} = \frac{vg(t)}{L_{M}} \dots \dots \dots (1)$$
See equation 2
Ip



As illustrated in Figure 2, when the current lp(t) rises up to lpk, the switch Q1 turns off. The constant peak current is given by: $lpk = \frac{Vcs}{r}$(2)

ΛΔ

$$Ipk = \frac{1}{Rcs}$$

The energy stored in the magnetizing inductance $L_{\mbox{\scriptsize M}}$ each cycle is therefore:

$$Eg = \frac{1}{2} \cdot L_{M} \cdot Ipk^{2} \dots (3)$$

So the power transferring from input to output is given by: $P = \frac{1}{2} \cdot L_{M} \cdot lpk^{2} \cdot f_{SW} \dots \dots \dots \dots (4)$

Where f_{SW} is the switching frequency. When the peak current lpk is constant, the output power depends on the switching frequency f_{SW}.





Operation Description (cont.)

Constant Voltage Operation

The AP3965/66/71 captures the auxiliary winding feedback voltage at FB pin and operates in constant-voltage (CV) mode to regulate the output voltage. Assuming the secondary winding is master, the auxiliary winding is slave during the D1 on-time. The auxiliary voltage is given by:

Where V_d is the diode forward drop voltage, N_{AUX} is the turns of auxiliary winding, and N_S is the turns of secondary winding.

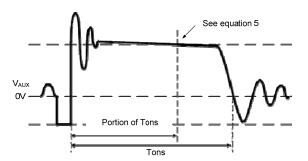


Figure 3. Auxiliary Voltage Waveform

The output voltage is different from the secondary voltage in a diode forward drop voltage V_d which depends on the current. If the secondary voltage is always detected at a constant secondary current, the difference between the output voltage and the secondary voltage will be a fixed V_d . The voltage detection point is portion of Tons after D1 is turned on. The CV loop control function of AP3965/66/71 then generates a D1 off-time to regulate the output voltage.

Constant Current Operation

The AP3965/66/71 is designed to work in constant current (CC) mode. Figure 4 shows the secondary current waveforms.

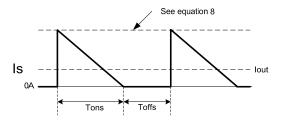


Figure 4. Secondary Current Waveform

In CC operation, the CC loop control function of AP3965/66/71 will keep a fixed proportion between D1 on-time Tons and D1 off-time Toffs by discharging or charging the built-in capacitance connected. This fixed proportion is

$$\frac{\text{Tons}}{\text{Toffs}} = \frac{4}{2} \dots \dots (6)$$

The relation between the output constant-current and secondary peak current lpks is given by:

$$I_{OUT} = \frac{1}{2} \cdot Ipks \cdot \frac{Tons}{Tons + Toffs} \dots \dots \dots (7)$$

At the instant of D1 turn-on, the primary current transfers to the secondary at an amplitude of:

$$lpks = \frac{N_P}{N_S} \cdot lpk \dots (8)$$





Operation Description (cont.)

Thus the output constant current is given by:

$$I_{OUT} = \frac{1}{3} \cdot \frac{N_{P}}{N_{S}} \cdot Ipk \dots (9)$$

Leading Edge Blanking (LEB)

When the power switch is turned on, a turn-on spike on the output pulse rising edge will occur on the sense-resistor. To avoid false termination of the switching pulse, a typical 500ns leading edge blanking is built in. During this blanking period, the current sense comparator is disabled and the gate driver cannot be switched off.

The built-in LEB in AP3965/66/71 has shorter delay time from current sense terminal to output pulse than those IC solutions adopting external RC filter as LEB.

Built-in Cable Compensation

The AP3965/66/71 has built-in fixed voltage of 0.35V typical to compensate the drop of output cable when the load is changed from zero to full load. A typical 0.01µF external capacitor connected to the CPC pin is used to smooth voltage signal for cable compensation.

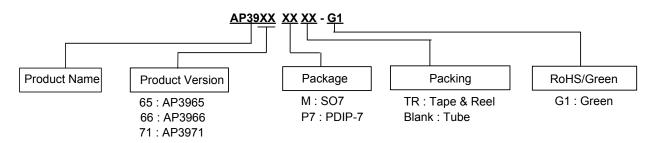
Over Temperature Protection

The AP3965/66/71 has internal thermal sensing circuit to shut down the PFM driver output when the die temperature reaches 160°C typical. When the die temperature drops about 40°C, the IC will recover automatically to normal operation.





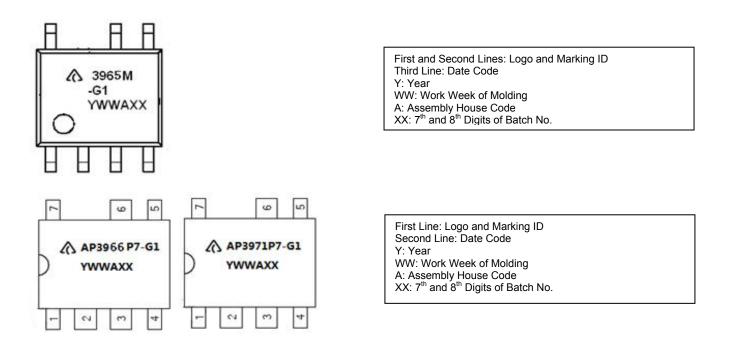
Ordering Information



Diodes IC's Pb-free products with "G1" suffix in the part number, are RoHS compliant and green.

Package	Temperature Range	Part Number	Marking ID	Packing	
S07		AP3965MTR-G1	3965M-G1	4,000/Tape & Reel	
PDIP-7	-40°C to 85°C	AP3966P7-G1	AP3966P7-G1	50/Tube	
		AP3971P7-G1	AP3971P7-G1	50/Tube	

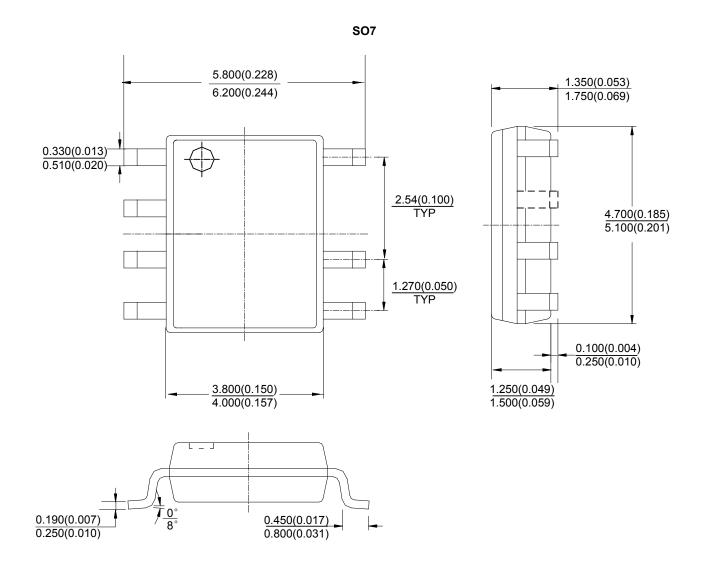
Marking Information







Package Outline Dimensions (All dimensions in mm(inch).)

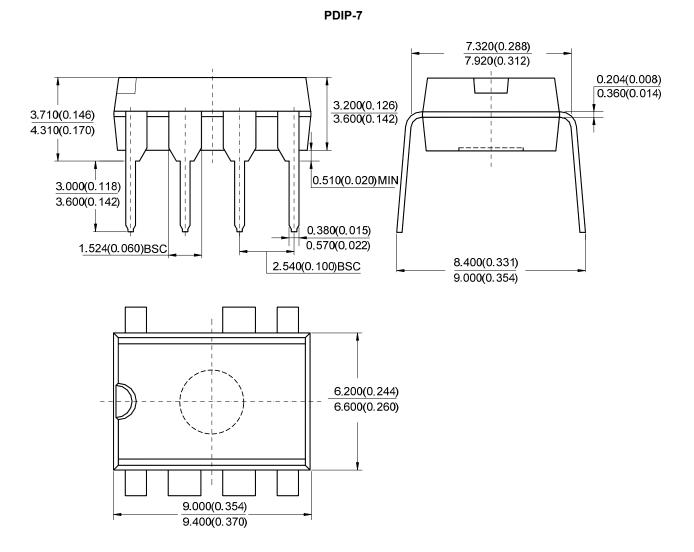


Note: Eject hole, oriented hole and mold mark is optional.





Package Outline Dimensions (cont.) (All dimensions in mm (inch).)

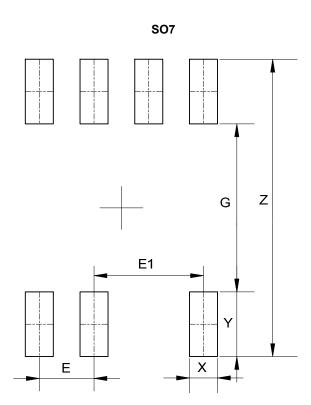


Note: Eject hole, oriented hole and mold mark is optional





Suggested Pad Layout



Dimensions	Z	G	X	Y	E	E1
	(mm)/(inch)	(mm)/(inch)	(mm)/(inch)	(mm)/(inch)	(mm)/(inch)	(mm)/(inch)
Value	6.900/0.272	3.900/0.154	0.650/0.026	1.500/0.059	1.270/0.050	2.540/0.100





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